

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Seong-Hoon Kim	07/05/2006
RECEIVING PARTY DATA	
Name:	S. Will International Co., LTD
Street Address:	#610 Kranz Techno, 5442-Sandaewon-Dong
Internal Address:	Jungwon-gu, Seongnam
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State/Country:	KOREA, REPUBLIC OF
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	11415755
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NAME OF SUBMITTER:	Brian Kinnear
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PATENT
Attorney Docket No. 830001.US0
Client Matter No. 53963.830001.US0

ASSIGNMENT

WHEREAS, I Kim, Seong-Hoon, have made a certain new and useful invention relating to STRUCTURE FOR INLAYING PRECIOUS METAL IN AN OUTER PERIPHERAL SURFACE OF A RING AND METHOD FOR MANUFACTURING A RING INLAID WITH PRECIOUS METAL IN AN OUTER PERIPHERAL SURFACE, for which I have made application for Letters Patent of the United States, said application being identified by Serial No. 11/415,755 and as Attorney Docket No. 830001.US0;

WHEREAS, S. WILL INTERNATIONAL CO., LTD (hereinafter "Assignee"), a Corporation, whose address #610 Kranz Techno, 5442- Sandae-won-Dong, Jungwon-gu, Seongnam, Gyeonggi-Do, Republic of Korea, is desirous of acquiring the entire interest in and to said invention, said application, and the Letters Patent to be obtained therefor;

NOW THEREFORE, for valuable consideration, receipt and adequacy of which is hereby acknowledged, I have sold, assigned, and set over, and do hereby sell, assign, and set over, unto the Assignee and said Assignee's legal representatives, successors, and assigns, the entire right, title, and interest in and to said invention, said application, and the Letters Patent, both foreign and domestic, that may or shall issue thereon; and I do hereby authorize and request the Commissioner of Patents and Trademarks to issue said Letters Patent to the above-mentioned Assignee, consistent with the terms of this Assignment.

UPON SAID CONSIDERATION, I do hereby covenant and agree with the said Assignee that I will not execute any writing or do any act whatsoever conflicting with these presents, and that I will, at any time upon request, without further or additional consideration, but at the expense of the said assignee, execute such additional assignments and other writings and do such additional acts as said Assignee may deem necessary or desirable to

perfect the Assignee's enjoyment of this grant, and render all necessary assistance in making application for and obtaining original, divisional, continuation, continuation-in-part, renewal, continuing, reissued or extended Letters Patent of the United States, or of any and all foreign countries, on said invention, and in enforcing any rights or chose an action accruing as a result of such applications or patents, by giving testimony in any proceedings or transactions involving such applications or patents, and by executing preliminary statements and other affidavits, it being understood that the foregoing covenant and agreement shall bind, and inure to the benefit of, the assigns and legal representatives of both parties.

IN WITNESS WHEREOF, and having read this entire document including all prior pages, I have hereunto set my hand and affixed my seal on the date hereinafter set forth.

Date: 05/07/2006



Kim, Seong-Hoon

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